

### 3-Pin Microcontroller Reset Monitors

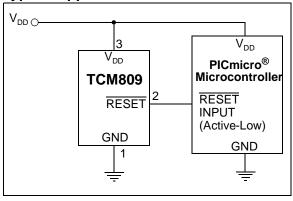
#### **Features**

- Precision V<sub>DD</sub> Monitor for 2.5V, 3.0V, 3.3V, 5.0V Nominal System Voltage Supplies
- 140 msec Minimum RESET Time Out Period
- RESET Output to V<sub>DD</sub> = 1.0V (TCM809)
- Low Supply Current, 9 μA (typ.)
- V<sub>DD</sub> Transient Immunity
- Small 3-Pin SC-70 and SOT-23B Packages
- · No External Components
- Push-Pull RESET Output
- Temperature Range:
  - Industrial, SC-70 (E): -40°C to +85°C
  - Extended, SOT-23, SC-70 (V): -40°C to +125°C

#### **Applications**

- · Computers
- · Embedded Systems
- · Battery-Powered Equipment
- Critical Microcontroller Power Supply Monitoring
- Automotive

#### **Typical Application Circuit**



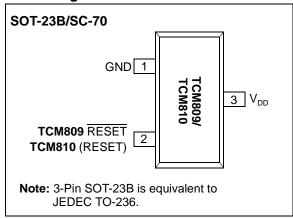
#### **General Description**

The TCM809 and TCM810 are cost-effective system supervisor circuits designed to monitor  $V_{DD}$  in digital systems and provide a reset signal to the host processor, when necessary. No external components are required.

The RESET output is typically driven active within 65 µsec of  $V_{DD}$  falling through the reset voltage threshold. RESET is maintained active for a minimum of 140 msec after  $V_{DD}$  rises above the reset threshold. The TCM810 has an active-high RESET output, while the TCM809 has an active-low RESET output. The output of the TCM809/TCM810 is valid down to  $V_{DD} = 1V$ . Both devices are available in 3-Pin SC-70 and SOT-23B packages.

The TCM809/TCM810 is optimized to reject fast transient glitches on the  $V_{DD}$  line. A low supply current of 9  $\mu$ A (typ.,  $V_{DD}$  = 3.3V) make these devices suitable for battery-powered applications.

#### **Pin Configurations**



# 1.0 ELECTRICAL CHARACTERISTICS

#### **Absolute Maximum Ratings†**

Supply Voltage (V <sub>DD</sub> to GND)6.0V
$\overline{\mbox{RESET}},$ RESET – 0.3V to (V_DD +0.3V)
Input Current, V <sub>DD</sub> 20 mA
Output Current, RESET, RESET20 mA
dV/dt (V <sub>DD</sub> )100V/μsec
Operating Temperature Range 40°C to +125°C
Power Dissipation ( $T_A$ = 70°C): 3-Pin SOT-23B (derate 4 mW/°C above +70°C)320 mW 3-Pin SC-70 (derate 2.17 mW/°C above +70°C)174 mW
Storage Temperature Range – 65°C to +150°C
Maximum Junction Temperature, T <sub>J</sub> 150°C

<sup>†</sup> Notice: Stresses above those listed under "Maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

#### **PIN FUNCTION TABLE**

NAME	FUNCTION
GND	Ground.
RESET (TCM809)	RESET push-pull output remains low while V <sub>DD</sub> is below the reset voltage threshold and for 240 msec (140 msec min.) after V <sub>DD</sub> rises above reset threshold.
RESET (TCM810)	RESET push-pull output remains high while V <sub>DD</sub> is below the reset voltage threshold and for 240 msec (140 msec min.) after V <sub>DD</sub> rises above reset threshold.
$V_{DD}$	Supply voltage (+2.5V, +3.0V, +3.3V, +5.0V).

#### **ELECTRICAL CHARACTERISTICS**

 $V_{DD}$  = Full Range,  $T_A$  = Operating Temperature Range, unless otherwise noted. Typical values are at  $T_A$  = +25°C,  $V_{DD}$  = 5V for L/M/J, 3.3V for T/S, 3.0V for R and 2.5V for Z (**Note 1**).

V <sub>DD</sub> = 3V for <i>Living</i> , 3.3V for 1/3, 3.5V for K and 2.5V for <i>L</i> (Note 1).									
Parameter	Sym	Min	Тур	Max	Units	Test Conditions			
V <sub>DD</sub> Range		1.0	_	5.5	V	$T_A = 0$ °C to +70°C	}		
		1.2	_	5.5		$T_A = -40^{\circ}C \text{ to } +12^{\circ}$	25°C		
Supply Current	I <sub>CC</sub>	_	12	30	μA	TCM8xxL/M/J:	V <sub>DD</sub> < 5.5V		
			9	25		TCM8xxR/S/T/Z:	V <sub>DD</sub> < 3.6V		
Reset Threshold (Note 2)	$V_{TH}$	4.56	4.63	4.70	V	TCM8xxL:	T <sub>A</sub> = +25°C		
		4.50		4.75			$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		4.31	4.38	4.45	V	TCM8xxM:	T <sub>A</sub> = +25°C		
		4.25		4.50	V		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		3.93	4.00	4.06	V	TCM809J:	T <sub>A</sub> = +25°C		
		3.89		4.10	V		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		3.04	3.08	3.11	V	TCM8xxT:	$T_A = +25$ °C		
		3.00	_	3.15	V		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		2.89	2.93	2.96	V	TCM8xxS:	T <sub>A</sub> = +25°C		
		2.85	_	3.00	V		$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$		
		2.59	2.63	2.66	V	TCM8xxR:	$T_A = +25$ °C		
		2.55	_	2.70	V		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
		2.28	2.32	2.35	V	TCM8xxZ:	$T_A = +25$ °C		
		2.25	l	2.38	V		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
Reset Threshold Tempco			30		ppm/°C				
V <sub>DD</sub> to Reset Delay,			65	1	µsec	$V_{DD} = V_{TH}$ to $(V_{TH})$	<sub>1</sub> – 100 mV) <b>(Note 2)</b>		
Reset Active Time Out Period		140	320	560	msec				

Note 1: Production testing done at  $T_A = +25$ °C, overtemperature limits ensured by QC screen.

<sup>2:</sup> RESET output for TCM809, RESET output for TCM810.

### **ELECTRICAL CHARACTERISTICS (CONTINUED)**

 $V_{DD}$  = Full Range,  $T_A$  = Operating Temperature Range, unless otherwise noted. Typical values are at  $T_A$  = +25°C,  $V_{DD}$  = 5V for L/M/J, 3.3V for T/S, 3.0V for R and 2.5V for Z **(Note 1)**.

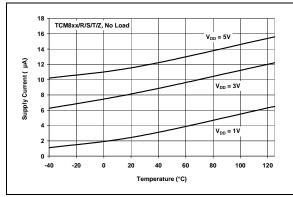
י.				. ,					
Parameter	Sym	Min	Тур	Max	Units	Test Conditions			
RESET Output Voltage	V <sub>OL</sub>	_		0.3	V	TCM809R/S/T/Z: $V_{DD} = V_{TH} \text{ min, } I_{SINK} = 1.2 \text{ mA}$			
Low ( <b>TCM809</b> )		_	_	0.4		TCM809L/M/J: $V_{DD} = V_{TH} \text{ min, } I_{SINK} = 3.2 \text{ mA}$			
		_	ı	0.3		V <sub>DD</sub> > 1.0V, I <sub>SINK</sub> = 50 μA			
RESET Output Voltage	V <sub>OH</sub>	0.8 V <sub>DD</sub>	-	_	V	TCM809R/S/T/Z: $V_{DD} > V_{TH}$ max, $I_{SOURCE} = 500 \mu A$			
High ( <b>TCM809</b> )		V <sub>DD</sub> – 1.5		_		<b>TCM809</b> L/M/J: $V_{DD} > V_{TH} \text{ max}$ , $I_{SOURCE} = 800 \mu\text{A}$			
RESET Output Voltage	V <sub>OL</sub>	_	1	0.3	V	<b>TCM810</b> R/S/T/Z: $V_{DD} = V_{TH}$ max, $I_{SINK} = 1.2$ mA			
Low ( <b>TCM810</b> )		_	_	0.4		<b>TCM810</b> L/M: $V_{DD} = V_{TH} \text{ max}$ , $I_{SINK} = 3.2 \text{ mA}$			
RESET Output Voltage High ( <b>TCM810</b> )	V <sub>OH</sub>	0.8 V <sub>DD</sub>	_	_	V	$1.8 < V_{DD} < V_{TH} min, I_{SOURCE} = 150 \mu A$			

Note 1: Production testing done at  $T_A = +25$ °C, overtemperature limits ensured by QC screen.

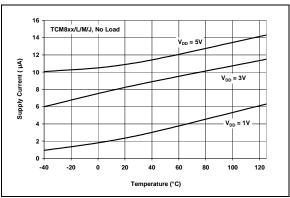
2: RESET output for TCM809, RESET output for TCM810.

#### 2.0 TYPICAL PERFORMANCE CHARACTERISTICS

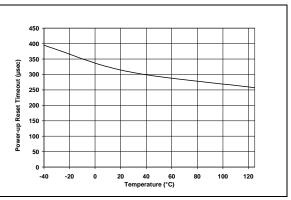
**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



**FIGURE 2-1:** Supply Current vs. Temperature.



**FIGURE 2-2:** Supply Current vs. Temperature.



**FIGURE 2-3:** Power-up Reset Time Out vs. Temperature.

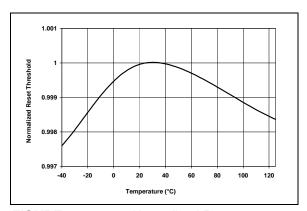


FIGURE 2-4: Normalized Reset Threshold vs. Temperature.

#### 3.0 APPLICATIONS INFORMATION

### 3.1 V<sub>DD</sub> Transient Rejection

The TCM809/TCM810 provides accurate  $V_{DD}$  monitoring and reset timing during power-up, power-down and brown-out/sag conditions. These devices also reject negative-going transients (glitches) on the power supply line. Figure 3-1 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive that lies under the curve will not generate a reset signal.

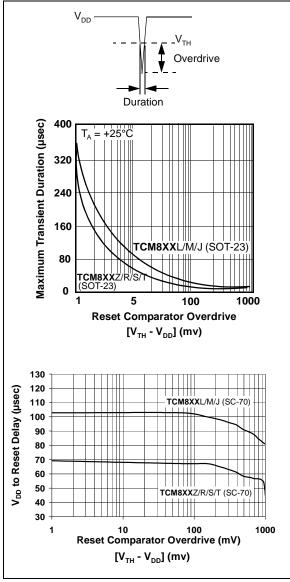
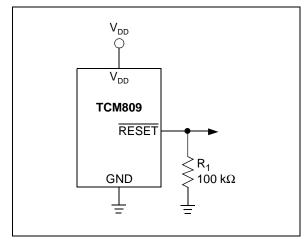


FIGURE 3-1: Maximum Transient Duration vs. Overdrive for Glitch Rejection at +25°C.

Combinations above the curve are detected as a brown-out or power-down condition. Transient immunity can be improved by adding a capacitor in close proximity to the V<sub>DD</sub> pin of the TCM809/TCM810.

# 3.2 RESET Signal Integrity During Power-Down

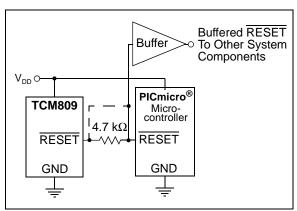
The TCM809  $\overline{\text{RESET}}$  output is valid to  $V_{DD}$  = 1.0V. Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the microcontroller will be floating at an undetermined voltage. Most digital systems are completely shut down well above this voltage. However, in situations where RESET must be maintained valid to  $V_{DD} = 0V$ , a pull-down resistor must be connected from RESET to ground to discharge stray capacitances and hold the output low (Figure 3-2). This resistor value, though not critical, should be chosen such that it does not appreciably load RESET under normal operation (100 k $\Omega$  will be suitable for most applications). Similarly, a pull-up resistor to V<sub>DD</sub> is required for the TCM810 to ensure a valid high RESET for V<sub>DD</sub> below 1.0V.



**FIGURE 3-2:** The addition of  $R_1$  at the <u>RESET</u> output of the TCM809 ensures that the <u>RESET</u> output is valid to  $V_{DD} = 0V$ .

# 3.3 Controllers and Processors With Bidirectional I/O Pins

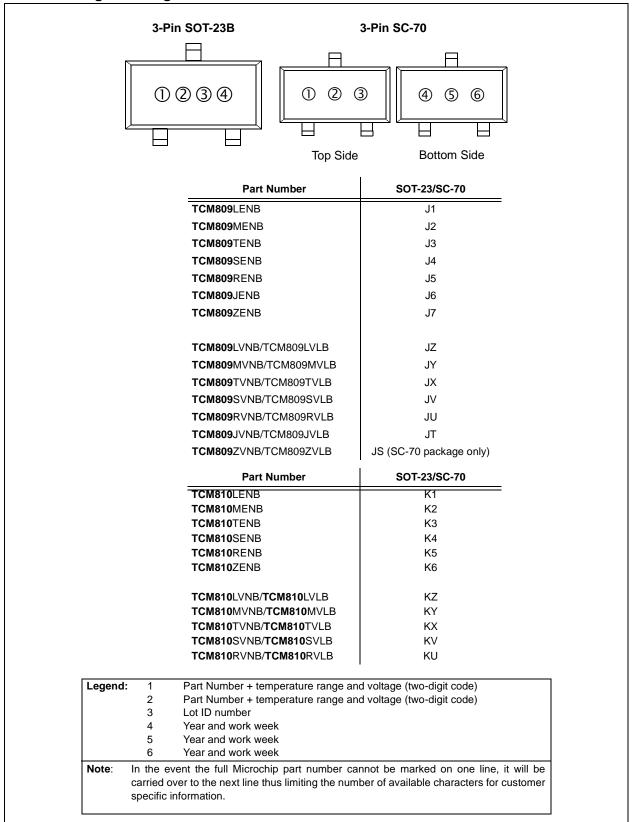
Some microcontrollers have bidirectional reset pins. Depending on the current drive capability of the controller pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k $\Omega$  resistor in series with the output of the TCM809/TCM810 (Figure 3-3). If there are other components in the system that require a reset signal, they should be buffered so as not to load the reset line. If the other components are required to follow the reset I/O of the microcontroller, the buffer should be connected as shown with the solid line.



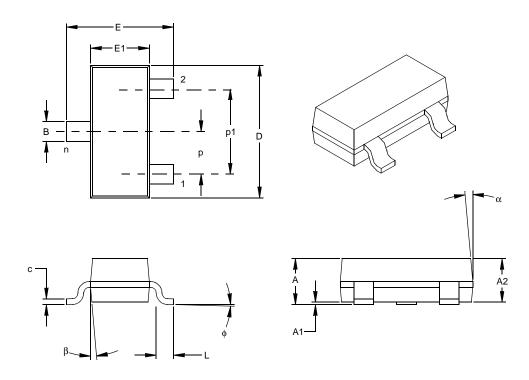
**FIGURE 3-3:** Interfacing the TCM809 to a Bidirectional RESET I/O.

#### 4.0 PACKAGING INFORMATION

#### 4.1 Package Marking Information



### 3-Lead Plastic Small Outline Transistor (NB) (SOT-23)



	Units		INCHES*		MILLIMETERS			
Dimension	MIN	NOM	MAX	MIN	MIN NOM			
Number of Pins	n		3			3		
Pitch	р		.038			0.96		
Outside lead pitch (basic)	p1		.076			1.92		
Overall Height	Α	.035	.040	.044	0.89	1.01	1.12	
Molded Package Thickness	A2	.035	.037	.040	0.88	0.95	1.02	
Standoff §	A1	.000	.002	.004	0.01	0.06	0.10	
Overall Width	Е	.083	.093	.104	2.10	2.37	2.64	
Molded Package Width	E1	.047	.051	.055	1.20	1.30	1.40	
Overall Length	D	.110	.115	.120	2.80	2.92	3.04	
Foot Length	L	.014	.018	.022	0.35	0.45	0.55	
Foot Angle	ф	0	5	10	0	5	10	
Lead Thickness	С	.004	.006	.007	0.09	0.14	0.18	
Lead Width	В	.015	.017	.020	0.37	0.44	0.51	
Mold Draft Angle Top	α	0	5	10	0	5	10	
Mold Draft Angle Bottom	β	0	5	10	0	5	10	

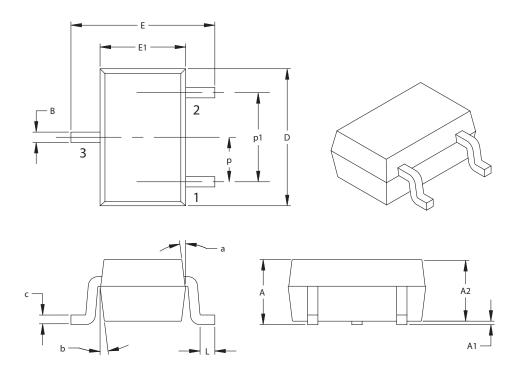
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: TO-236

Drawing No. C04-104

<sup>\*</sup> Controlling Parameter § Significant Characteristic

### 3-Lead Plastic Small Outline Transistor (LB) (SC-70)



	Units			MILLIMETERS*			
Dimension Limi	MIN	MAX	MIN	MAX			
Number of Pins		3	3	3			
Pitch	р	.026 BS	iC.	0.65 BSC.			
Outside lead pitch (basic)	p1	.051 BS	iC.	1.30 BS	1.30 BSC.		
Overall Height	Α	.031	.043	0.80	1.10		
Molded Package Thickness	A2	.031	.039	0.80	1.00		
Standoff	A1	.000	.0004	0.00	.010		
Overall Width	E	.071	.094	1.80	2.40		
Molded Package Width	E1	.045	.053	1.15	1.35		
Overall Length	D	.071	.089	1.80	2.25		
Foot Length	L	.004	.016	0.10	0.41		
Lead Thickness	С	.003	.010	0.08	0.25		
Lead Width	В	.006	.006 .016		0.40		
Mold Draft Angle Top	a	8°	12°	8°	12°		
Mold Draft Angle Bottom	b	8°	12°	8°	12°		

<sup>\*</sup>Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

JEITA (EIAJ) Equivalent: SC70 Drawing No. C04-104

### 4.2 Product Tape and Reel Specifications

### FIGURE 4-1: EMBOSSED CARRIER DIMENSIONS (8, 12, 16, AND 24 MM TAPE ONLY)

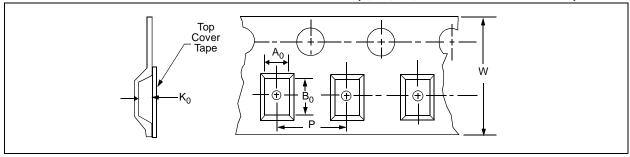
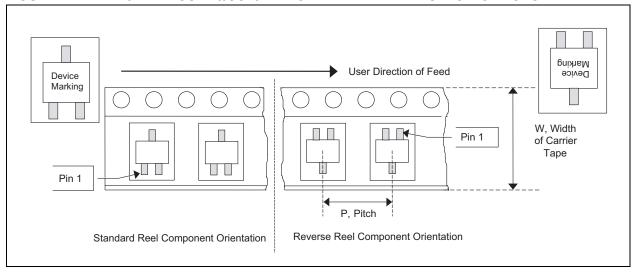


TABLE 1: CARRIER TAPE/CAVITY DIMENSIONS

Case	Case Package Outline Type		Carrier Dimensions		D	Cavity imensio	าร	Output Quantity	Reel Diameter in
Outline			W mm	P mm	A0 mm	B0 mm	K0 mm	Units	mm
NB	SOT-23	3L	8	4	3.15	2.77	1.22	3000	180
LB	SC-70	3L	8	4	2.4	2.4	1.19	3000	180

#### FIGURE 4-2: 3-LEAD SOT-23/SC70 DEVICE TAPE AND REEL SPECIFICATIONS



#### PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	<u>X</u>	<u> X</u>	XXXXX	Exa	imples:	
	V <sub>DD</sub> Reset reshold	 Temperature Range	Package	a)	TCM809LENB713:	SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +85°C, Tape and Reel.
Device:	TCM810:	Supervisor circuit v Supervisor circuit v		b)	TCM809LVLB713:	SC-70-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
V <sub>DD</sub> Reset Threshold:	M = 4 J = 4 T = 3 S = 2 R = 2	.63V .38V .00V .08V .93V .63V		c)	TCM809LVNB713:	SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
Temperature Range:	E = -4	.32V 40°C to +85°C 40°C to +125°C		a)	TCM810MENB713:	SOT-23B-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +85°C, Tape and Reel.
Package:		SOT-23B, 3-pin (Tape		b)	TCM810RVLB713:	SOT-23B-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
				c)	TCM810TVLB713:	SC-70-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +125°C, Tape and Reel.

### **Sales and Support**

#### **Data Sheets**

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China - Shanghai

Room 701, Bldg. B Far East International Plaza No. 317 Xian Xia Road Shanghai, 200051 Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

**China - Shenzhen** Rm. 1812, 18/F, Building A, United Plaza No. 5022 Binhe Road, Futian District

Shenzhen 518033, China Tel: 86-755-82901380 Fax: 86-755-8295-1393

China - Shunde

Room 401, Hongjian Building, No. 2 Fengxiangnan Road, Ronggui Town, Shunde District, Foshan City, Guangdong 528303, China Tel: 86-757-28395507 Fax: 86-757-28395571

China - Qingdao

Rm. B505A, Fullhope Plaza, No. 12 Hong Kong Central Rd. Qingdao 266071, China

Tel: 86-532-5027355 Fax: 86-532-5027205

India

Divyasree Chambers 1 Floor, Wing A (A3/A4) No. 11, O'Shaugnessey Road Bangalore, 560 025, India Tel: 91-80-22290061 Fax: 91-80-22290062

Japan

Benex S-1 6F 3-18-20, Shinyokohama Kohoku-Ku, Yokohama-shi Kanagawa, 222-0033, Japan Tel: 81-45-471-6166 Fax: 81-45-471-6122 Korea

168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea 135-882 Tel: 82-2-554-7200 Fax: 82-2-558-5932 or

82-2-558-5934

**Singapore** 200 Middle Road #07-02 Prime Centre Singapore, 188980

Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan

Kaohsiung Branch 30F - 1 No. 8 Min Chuan 2nd Road Kaohsiung 806, Taiwan Tel: 886-7-536-4818 Fax: 886-7-536-4803

Taiwan

Taiwan Branch 11F-3, No. 207 Tung Hua North Road Taipei, 105, Taiwan

Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

#### **EUROPE**

Austria

Durisolstrasse 2 A-4600 Wels Austria Tel: 43-7242-2244-399

Tel: 43-7242-2244-399 Fax: 43-7242-2244-393

Denmark

Regus Business Centre Lautrup hoj 1-3 Ballerup DK-2750 Denmark Tel: 45-4420-9895 Fax: 45-4420-9910

France

Parc d'Activite du Moulin de Massy 43 Rue du Saule Trapu Batiment A - ler Etage 91300 Massy, France Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Steinheilstrasse 10 D-85737 Ismaning, Germany Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy

Via Quasimodo, 12 20025 Legnano (MI) Milan, Italy Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands

P. A. De Biesbosch 14 NL-5152 SC Drunen, Netherlands Tel: 31-416-690399

Fax: 31-416-690340 United Kingdom 505 Eskdale Road

Winnersh Triangle Wokingham Berkshire, England RG41 5TU Tel: 44-118-921-5869 Fax: 44-118-921-5820

02/17/04